74HC244-Q100; 74HCT244-Q100

Octal buffer/line driver; 3-state

Rev. 4 — 27 July 2021

Product data sheet

1. General description

The 74HC244-Q100; 74HCT244-Q100 is an 8-bit buffer/line driver with 3-state outputs. The device can be used as two 4-bit buffers or one 8-bit buffer. The device features two output enables ($1\overline{OE}$ and $2\overline{OE}$), each controlling four of the 3-state outputs. A HIGH on $n\overline{OE}$ causes the outputs to assume a high-impedance OFF-state. Inputs include clamp diodes that enable the use of current limiting resistors to interface inputs to voltages in excess of V_{CC} .

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
 - Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Wide supply voltage range from 2.0 to 6.0 V
- · CMOS low power dissipation
- · High noise immunity
- · Latch-up performance exceeds 100 mA per JESD 78 Class II Level B
- Input levels:
 - For 74HC244-Q100: CMOS level
 - For 74HCT244-Q100: TTL level
- Octal bus interface
- Non-inverting 3-state outputs
- · Complies with JEDEC standards:
 - JESD8C (2.7 V to 3.6 V)
 - JESD7A (2.0 V to 6.0 V)
- ESD protection:
 - MIL-STD-883, method 3015 exceeds 2000 V
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)
- · Multiple package options
- DHVQFN package with Side-Wettable Flanks enabling Automatic Optical Inspection (AOI) of solder joints

3. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74HC244D-Q100	-40 °C to +125 °C		plastic small outline package; 20 leads;	SOT163-1
74HCT244D-Q100			body width 7.5 mm	
74HC244PW-Q100	-40 °C to +125 °C	TSSOP20	plastic thin shrink small outline package;	SOT360-1
74HCT244PW-Q100	1		20 leads; body width 4.4 mm	

Type number	Package	ckage							
	Temperature range	Name	Description	Version					
74HC244BQ-Q100	-40 °C to +125 °C	DHVQFN20	plastic dual in-line compatible thermal	SOT764-1					
74HCT244BQ-Q100			enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 × 4.5 × 0.85 mm						

4. Functional diagram

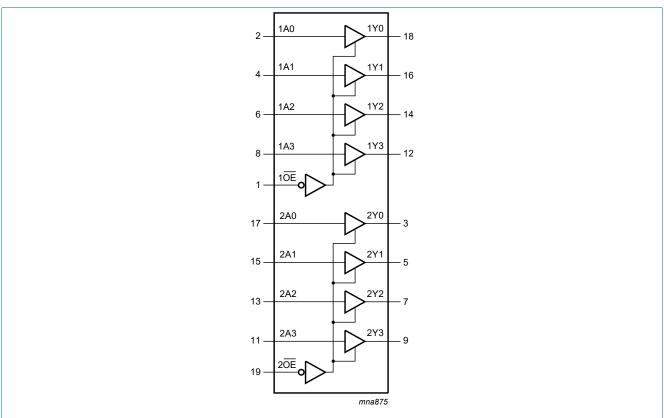
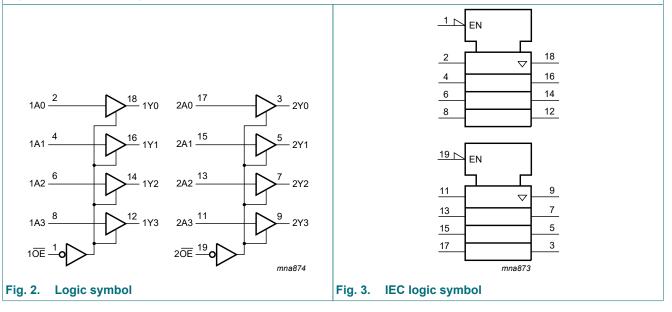
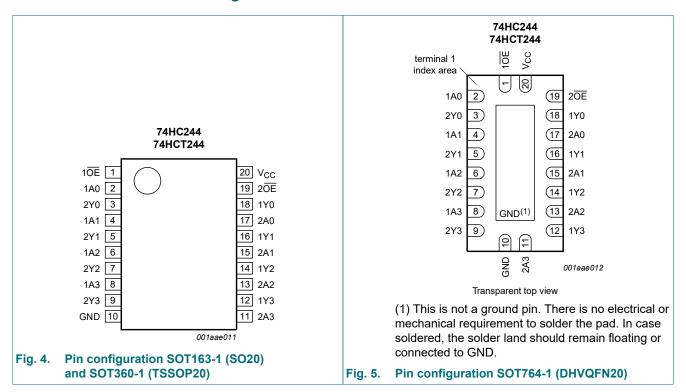


Fig. 1. Functional diagram



5. Pinning information

5.1. Pinning



5.2. Pin description

Table 2. Pin description

bie 2. Fill description								
Pin	Description							
1, 19	output enable input (active LOW)							
2, 4, 6, 8	data input							
3, 5, 7, 9	bus output							
10	ground (0 V)							
17, 15, 13, 11	data input							
18, 16, 14, 12	bus output							
20	supply voltage							
	1, 19 2, 4, 6, 8 3, 5, 7, 9 10 17, 15, 13, 11 18, 16, 14, 12							

6. Functional description

Table 3. Function table

H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

Input nOE	Output		
nOE	nAn	nYn	
L	L	L	
L	Н	Н	
Н	X	Z	

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+7	V
I _{IK}	input clamping current	$V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$	-	±20	mA
I _{OK}	output clamping current	$V_{O} < -0.5 \text{ V or } V_{O} > V_{CC} + 0.5 \text{ V}$	-	±20	mA
Io	output current	-0.5 V < V _O < V _{CC} + 0.5 V	-	±35	mA
I _{CC}	supply current		-	70	mA
I _{GND}	ground current		-70	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	[1]	-	500	mW

^[1] For SOT163-1 (SO20) package: P_{tot} derates linearly with 12.3 mW/K above 109 °C. For SOT360-1 (TSSOP20) package: P_{tot} derates linearly with 10.0 mW/K above 100 °C. For SOT764-1 (DHVQFN20) package: P_{tot} derates linearly with 12.9 mW/K above 111 °C.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
74HC24	4-Q100		'			
V _{CC}	supply voltage		2.0	5.0	6.0	V
VI	input voltage		0	-	V _{CC}	V
Vo	output voltage		0	-	V _{CC}	V
Δt/ΔV	input transition rise and fall rate	V _{CC} = 2.0 V	-	-	625	ns/V
		V _{CC} = 4.5 V	-	1.67	139	ns/V
		V _{CC} = 6.0 V	-	-	83	ns/V
T _{amb}	ambient temperature		-40	-	+125	°C
74HCT2	44-Q100		'	•	•	
V _{CC}	supply voltage		4.5	5.0	5.5	V
VI	input voltage		0	-	V _{CC}	V
Vo	output voltage		0	-	V _{CC}	V
Δt/ΔV	input transition rise and fall rate	V _{CC} = 4.5 V	-	1.67	139	ns/V
T _{amb}	ambient temperature		-40	-	+125	°C

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		-40 °C to	o +85 °C	-40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC24	4-Q100						1			
V _{IH}	HIGH-level	V _{CC} = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	V _{CC} = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
		V _{CC} = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V
V _{IL}	LOW-level	V _{CC} = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
	input voltage	V _{CC} = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V _{CC} = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V
	HIGH-level	V _I = V _{IH} or V _{IL}								
	output voltage	I _O = -20 μA; V _{CC} = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V
	voitage	I _O = -20 μA; V _{CC} = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		I _O = -20 μA; V _{CC} = 6.0 V	5.9	6.0	-	5.9	-	5.9	-	V
		I _O = -6.0 mA; V _{CC} = 4.5 V	3.98	4.32	-	3.84	-	3.7	-	V
		I_{O} = -7.8 mA; V_{CC} = 6.0 V	5.48	5.81	-	5.34	-	5.2	-	V
V _{OL}	LOW-level	V _I = V _{IH} or V _{IL}								
	output voltage	I _O = 20 μA; V _{CC} = 2.0 V	-	0	0.1	-	0.1	-	0.1	V
	Voltage	I _O = 20 μA; V _{CC} = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 20 μA; V _{CC} = 6.0 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 6.0 mA; V _{CC} = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
		I _O = 7.8 mA; V _{CC} = 6.0 V	-	0.16	0.26	-	0.33	-	0.4	V
I _I	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$	-	-	±0.1	-	±1.0	-	±1.0	μΑ
l _{OZ}	OFF-state output current	$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 6.0 \text{ V}$; $V_O = V_{CC}$ or GND	-	-	±0.5	-	±5.0	-	±10	μΑ
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0 \text{ V}$	-	-	8.0	-	80	-	160	μΑ
C _I	input capacitance		-	3.5	-	-	-	-	-	pF

74HC244-Q100; 74HCT244-Q100

Octal buffer/line driver; 3-state

Symbol	Parameter	Conditions		25 °C		-40 °C to	+85 °C	-40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HCT2	44-Q100					-				
V _{IH}	HIGH-level input voltage	V _{CC} = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	2.0	-	V
V _{IL}	LOW-level input voltage	el V _{CC} = 4.5 V to 5.5 V		1.2	0.8	-	0.8	-	0.8	V
V _{OH}	HIGH-level output voltage	$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 4.5 \text{ V}$								
		I _O = -20 μA	4.4	4.5	-	4.4	-	4.4	-	V
		I _O = -6 mA	3.98	4.32	-	3.84	-	3.7	-	V
V_{OL}	LOW-level output voltage	$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 4.5 \text{ V}$								
		I _O = 20 μA	-	0	0.1	-	0.1	-	0.1	V
	Voltage	I _O = 6.0 mA	-	0.16	0.26	-	0.33	-	0.4	V
l _l	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$	-	-	±0.1	-	±1.0	-	±1.0	μA
I _{OZ}	OFF-state output current	$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 5.5$ V; $V_O = V_{CC}$ or GND	-	-	±0.5	-	±5.0	-	±10	μΑ
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$; $I_O = 0 \text{ A}$	-	-	8.0	-	80	-	160	μA
$ \begin{array}{c c} \Delta I_{CC} & \text{additional} & \text{per input pin; } V_I = V_{CC} - 2.1 \text{ V;} \\ \text{supply} & \text{other inputs at } V_{CC} \text{ or GND;} \\ \text{current} & V_{CC} = 4.5 \text{ V to } 5.5 \text{ V; } I_O = 0 \text{ A} \\ \end{array} $		-	70	252	-	315	-	343	μΑ	
Cı	input capacitance		-	3.5	-	-	-	-	-	pF

10. Dynamic characteristics

Table 7. Dynamic characteristics

GND = 0 V; for test circuit see Fig. 8.

Symbol	Parameter	Conditions		25 °C		-40 °C t	o +85 °C	-40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC24	4-Q100						·		'	
t _{pd}	propagation	nAn to nYn; see Fig. 6 [1]								
	delay	V _{CC} = 2.0 V	-	30	110	-	145	-	165	ns
		V _{CC} = 4.5 V	-	11	22	-	28	-	33	ns
		$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$	-	9	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	9	19	-	24	-	28	ns
t _{en}	enable time	nOE to nYn; see Fig. 7 [2]								
		V _{CC} = 2.0 V	-	36	150	-	190	-	225	ns
		V _{CC} = 4.5 V	-	13	30	-	38	-	45	ns
		V _{CC} = 6.0 V	-	10	26	-	33	-	38	ns
t _{dis}	disable time	nOE to nYn; see Fig. 7 [3]								
		V _{CC} = 2.0 V	-	39	150	-	190	-	225	ns
		V _{CC} = 4.5 V	-	14	30	-	38	-	45	ns
		V _{CC} = 6.0 V	-	11	26	-	33	-	38	ns
t _t	transition	see <u>Fig. 6</u> [4]								
	time	V _{CC} = 2.0 V	-	14	60	-	75	-	90	ns
		V _{CC} = 4.5 V	-	5	12	-	15	-	18	ns
		V _{CC} = 6.0 V	-	4	10	-	13	-	15	ns
C _{PD}	power dissipation capacitance	per buffer; $V_I = GND$ to V_{CC} [5]	-	35	-	-	-	-	-	pF
74HCT2	44-Q100	1					·		1	
t _{pd}	propagation	nAn to nYn; see Fig. 6 [1]								
	delay	V _{CC} = 4.5 V	-	13	22	-	28	-	33	ns
		V _{CC} = 5.0 V; C _L = 15 pF	-	11	-	-	-	-	-	ns
t _{en}	enable time	\overline{OE} to nYn; V_{CC} = 4.5 V; [2] see Fig. 7	-	15	30	-	38	-	45	ns
t _{dis}	disable time	\overline{NOE} to nYn; V _{CC} = 4.5 V; [3] see Fig. 7	-	15	25	-	31	-	38	ns
t _t	transition time	V _{CC} = 4.5 V; see <u>Fig. 6</u> [4]	-	5	12	-	15	-	18	ns
C _{PD}	power dissipation capacitance	per buffer; [5] V _I = GND to V _{CC} - 1.5 V	-	35	-	-	-	-	-	pF

^[1] t_{pd} is the same as t_{PHL} and t_{PLH} .

 t_{en} is the same as t_{PZH} and t_{PZL} .

^[3] t_{dis} is the same as t_{PHZ} and t_{PLZ} .

 t_t is the same as t_{THL} and t_{TLH} . C_{PD} is used to determine the dynamic power dissipation (P_D in μW): $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where: f_i = input frequency in MHz; f_o = output frequency in MHz;

 C_L = output load capacitance in pF; V_{CC} = supply voltage in V; N = number of inputs switching; Σ ($C_L \times V_{CC}$ $^2 \times f_o$) = sum of outputs.

10.1. Waveforms and test circuit

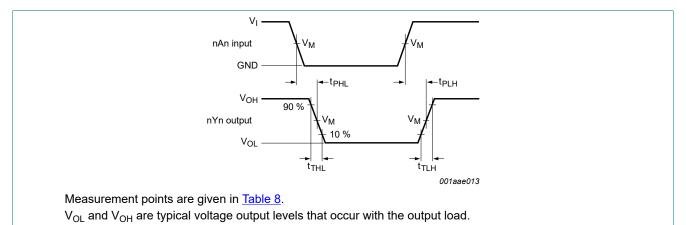


Fig. 6. Input (nAn) to output (nYn) propagation delays and output transition times

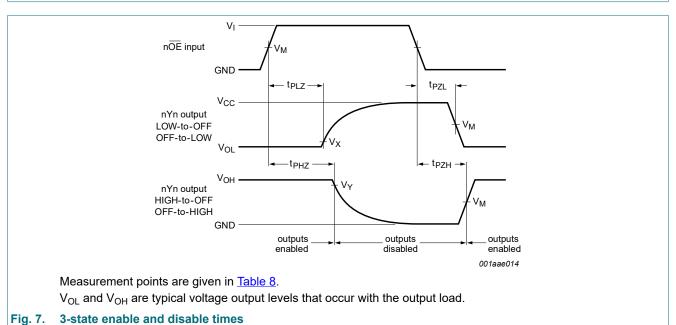
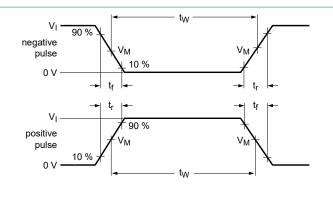
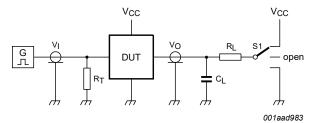


Table 8. Measurement points Type Input Output V_{M} V_{M} V_{Y} ٧x 74HC244-Q100 $0.5 \times V_{CC}$ $0.5 \times V_{CC}$ $0.1 \times V_{CC}$ $0.9 \times V_{CC}$ 74HCT244-Q100 1.3 V 1.3 V $0.1 \times V_{CC}$ $0.9 \times V_{CC}$

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Test data is given in Table 9.

Definitions test circuit:

 R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator.

C_L = Load capacitance including jig and probe capacitance.

R_L = Load resistance.

S1 = Test selection switch.

Fig. 8. Test circuit for measuring switching times

Table 9. Test data

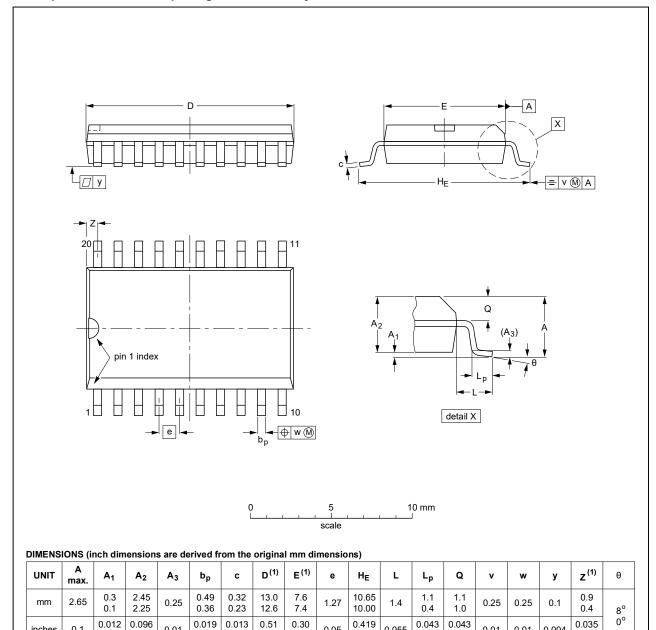
Туре	Input		Load		S1 position		
	V _I	t _r , t _f	C _L	R _L	t _{PHL} , t _{PLH}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}
74HC244-Q100	V _{CC}	6 ns	15 pF, 50 pF	1 kΩ	open	GND	V _{CC}
74HCT244-Q100	3 V	6 ns	15 pF, 50 pF	1 kΩ	open	GND	V _{CC}

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11. Package outline

SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



inches

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

0.019

0.014

0.013

0.009

0.51

0.49

0.30

0.29

	OUTLINE		REFER	EUROPEAN	ISSUE DATE		
	VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
	SOT163-1	075E04	MS-013				99-12-27 03-02-19

0.05

0.394

0.043

0.016

0.055

0.043

0.039

0.01

0.01

0.004

0.016

Fig. 9. Package outline SOT163-1 (SO20)

0.012

0.004

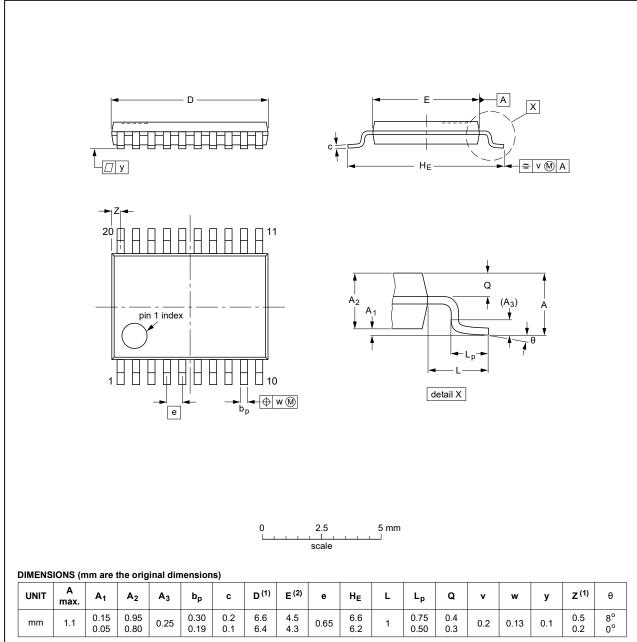
0.096

0.089

0.01

TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1



Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT360-1		MO-153				-99-12-27- 03-02-19	

Fig. 10. Package outline SOT360-1 (TSSOP20)

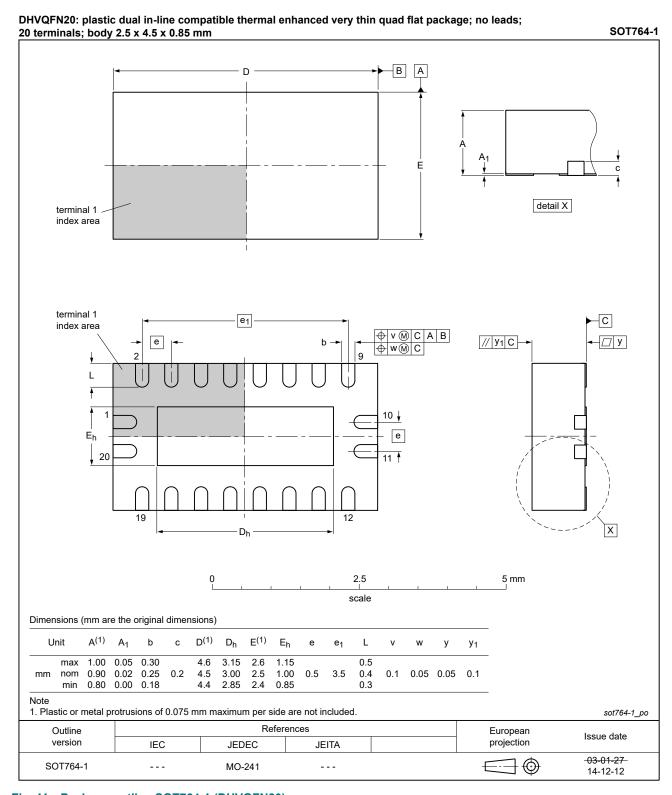


Fig. 11. Package outline SOT764-1 (DHVQFN20)

12. Abbreviations

Table 10. Abbreviations

Acronym	Description			
CMOS	Complementary Metal Oxide Semiconductor			
DUT	Device Under Test			
ESD	ElectroStatic Discharge			
НВМ	Human Body Model			
MIL	Military			
MM	Machine Model			
TTL	Transistor-Transistor Logic			

13. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes		
74HC_HCT244_Q100 v.4	20210727	Product data sheet	-	74HC_HCT244_Q100 v.3		
Modifications:	<u>Section 2</u> updated.					
74HC_HCT244_Q100 v.3	20200713	Product data sheet	-	74HC_HCT244_Q100 v.2		
Modifications:	<u>Section 2</u> updated.					
74HC_HCT244_Q100 v.2	20190927	Product data sheet	-	74HC_HCT244_Q100 v.1		
Modifications:	 The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. Legal texts have been adapted to the new company name where appropriate. Section 7: Derating values for P_{tot} total power dissipation have been updated. Package outline drawing Fig. 11 (DHVQFN20) updated. 					
74HC_HCT244_Q100 v.1	20120807	Product data sheet	-	-		

14. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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Product data sheet

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